SPECIFICATION

Model:	3535U06-08B75L12-C3-001
Date:	2019/07/03
NO:	

Approved	Checked	Drawn





3535U06-08B75L12-C3-001 Datasheet

The 3535 LED light source is a high-performance energy-saving device that can handle high heat and high drive current. 此款 3535 LED 光源是一种高性能节能器件,可以处理高热量和高驱动电流。



The Purple LED light source with peak wavelength ranging from 270nm to 280nm.

紫外 LED 光源峰值波长为 270nm~280nm。

This part has a foot print that is compatible to most of the same size LED in the market today.
此器件的焊盘兼容当今市场上大部分相同大小的 LED。

FEATURES/特点

- Deep UV LED with emission wavelength between 260nm to 280nm 具有发射波长的深紫外光 LED 在 260nm 至 280nm 之间
- Compatible with reflow soldering process 兼容回流焊工艺
- Low thermal resistance/热阻低
- Long operation life/寿命长
- Wide viewing angle at 120° 120° 大发光角度
- Superior ESD protection 优越的 ESD 保护
- Environmental friendly, RoHS compliance 材质环保,符合 RoHS 要求

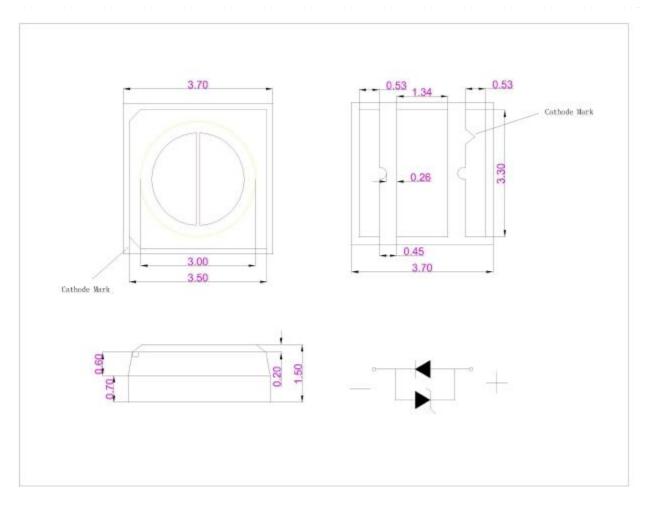
APPLICATIONS/应用

- Personal hygiene 个人卫生
- Portable devices 便携设备
- Water disinfection 水消毒
- Surface disinfection 表面消毒
- Air disinfection 空气消毒

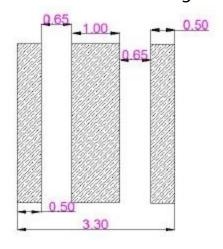
Note: The information in this document is subject to change without notice.

注:本文件中的信息如有变更, 恕不另行通知。

PACKAGE DIMENSIONS 封装尺寸



Recommended Solder Pad Design 推荐焊盘设计



Notes/注:

- 1. All dimensions in millimeters.所有尺寸单位为 mm
- 2. Thickness tolerance of copper plate is ±0.02mm. 铜材料片厚度公差为±0.02mm
- 3. Thickness tolerance of product is ±0.05mm. 产品厚度公差为±0.02mm
- 4. Tolerance is ±0.1mm unless otherwise noted. 如未特别注明,默认公差为±0.1mm

ABSOLUTE MAXIMUM RATINGS 最大限定参数(Ta=25℃)

Forward current 正向电流	I_{F}	100	mA
Peak Forward Current 正向脉冲电流	I _{FP}	150	mA
Reverse Voltage 反向电压	V_{R}	5	V
Power Dissipation 消耗功率	Pd	600	mW
Operating Temperature 工作温度	T_{opr}	-40~+80	$^{\circ}$ C
Storage Temperature 储存温度	T_{stg}	-40~+80	$^{\circ}$ C
Soldering Temperature 焊接温度	Tsld	Reflow Soldering: 260 seconds	°C for 10
LED Junction Temperature 结温	Tj	80	°C

CHARACTERISTICS 光电参数(Ta=25℃)

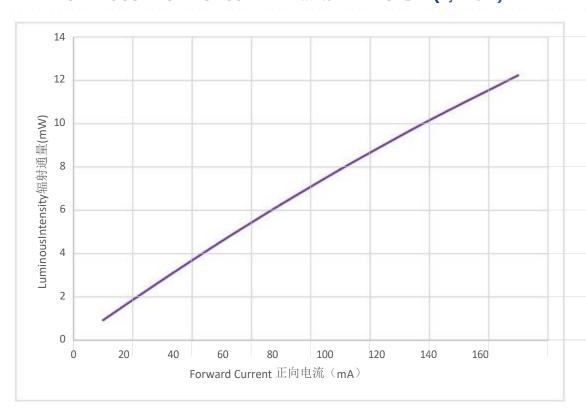
Reverse Current 反向漏电流	IR	VR=5V			10	UA
Forward Voltage 正向电压	V_{F}	I _F =100mA	5.0	5.8	7.0	V
Viewing Angle 发光角度	2θ1/2	I _F =100mA		120		deg.
Luminous Intensity 辐射通量	Фе	$I_F=100mA$	8	10	15	mw
peak wavelength 峰值波长	λP	I _F =100mA		275		nm

Notes/注:

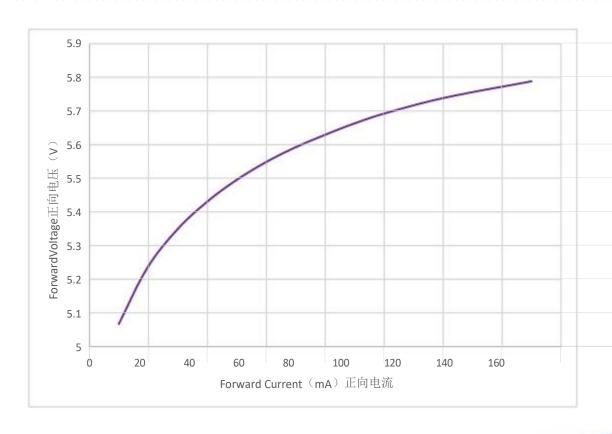
^{2.} peak wavelength is measured with an accuracy of ± 5%. 峰值波长的测量精度为± 5%。

^{3.} All measurements were made under the standardized environment of Shineon 所有的测量都是在易美的标准环境下进行的

RELATIVE LUMINOUS FLUX VS. CURRENT 相对光通量 VS 电流 (Tj=25℃)



ELECTRICAL CHARACTERISTICS 电特性(Tj=25℃)



SORTING RANKS 分光等级

(1) Luminous Intensity 辐射功率 (Tj=25℃)

Part Number 型号	Condition 条件	Rank	等级	Unit 单位
		LK	MA	
3535U06-08B75L12-XX-XXX	100mA	8.5-10	10-12	MW
		MB	MC	
		12-14	14-16	

(2) Forward Voltage 正向电压 (Tj=25℃)

Rank 等级	Condition	Min 最小值	Max 最大	Unit 单位
CD		5.2	5.6	
CE	100 1	5.6	6.0	V
DA	100mA	6.0	6.4	
DB		6.4	6.8	

(3) peak wavelength 峰值波长 (Tj=25℃)

Part Number 型号	Condition 条件	Rank 等级		Unit 单位
		QB	QC	
3535U06-08B75L12-XX-XXX	100mA	260-270	270-280	nm
		QD		
		280-290		

Notes/注:

 $^{1.\,10\%}$ tolerance for luminous intensity may be caused by measurement inaccuracy. 光辐射功率测量精度误差 $\pm\,5\%$

^{2.} Measurement Uncertainty of the Forward Voltage : ± 0.03V 正向电压测量误差:± 3%

REFLOW SOLDERING CHARACTERISTICS 回流焊特性

For Reflow Process 回流焊制程:

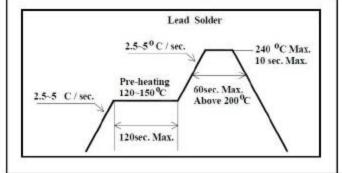
Preheating 预热: 140°C~160°C±5°C, within 2 minutes. 2 分钟

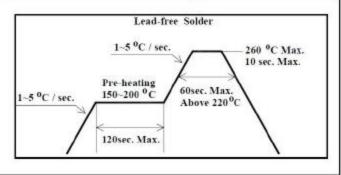
Operation heating 作业加热: 260°C(Max.) within 10 seconds.(Max)

260°C(最高) within 10 seconds.(最长)

Gradual Cooling (Avoid quenching).逐渐冷却(避免淬火)

Lead solder 有铅焊接		Lead-free solder 无铅焊接		
Pre-heat 预热	120-150°C	Pre-heat 预热	150-200°C	
Pre-heat time 预热实际那	120 sec.Max.	Pre-heat time 预热实际那	120 sec.Max.	
Peak Temperature 峰值温度	240°C Max.	Peak Temperature 峰值温度	260°C Max.	
Soldering time condition 回流焊时间	10 sec.Max.	阿撒姆爾 阿me condition	10 sec.Max.	





Notes 注:

The encapsulated material of the LEDs is silicone. Therefore the LEDs have a soft surface on the top of package. The pressure to the top surface will be influence to the reliability of the LEDs. Precautions should be taken to avoid the strong pressure on the encapsulated part. So when using the picking up nozzle, the pressure on the silicone resin should be proper.

由于 LED 的封装材料是硅胶,led 封装顶部表面是柔软的,顶部表面的压力会影响 led 的可靠性。应采取预防措施,以避免密封部件受到强大的压力。因此,在使用吸嘴时,应使硅胶表面的压力适中。

Test Items 测试项目	Test Duration 测试时长	Number of Damaged 不良数
Steady State Operating Life of High Temperature (HTOL) Ts=85°C, IF=Max 高温点亮稳态老化 Ts=85°C, IF=最大值	1000hrs	0/20
Steady State Operating Life of Low Temperature (LTOL) Ta=-40°C, IF=Max 低温点亮稳态老化 Ts=-40°C, IF=最大值	1000hrs	0/20
Pulse Wet Operating Life of High Temperature (PWHTOL) 高温高湿通断电老化 60°C/90%RH, IF30mins ON/30min OFF	500hrs	0/20
High Temperature Storage (HTS) 高温存储 80℃	1000hrs	0/20
Low Temperature Storage (LTS) 低温存储 -40°C	1000hrs	0/20
Thermal Shock (TS) -45°C~125°C 30min dwell 20sec transfer 冷热冲击-45°C 30min~125°C 30min,转换时间 20 秒	100cycles	0/20
Solder Resistance (SR) 265℃, 3X MSL 阻焊测试(3 遍潮气敏感度试验后)	5sec	0/20
Solder Ability (SA) 245°C5sec, 95% coverage 可焊性 95%覆盖	5sec	0/11
Mechanical Shock (MS) 1500G 0.5msec pulse shock 机械冲击(MS) 1500G 0.5 毫秒脉冲冲击	Each6 axis	0/6
Random Vibration (RV) 随机振动 6G RMS, 10-2000Hz, 10min	Per axis	0/6
Variable Vibration Frequency (VVF) 10-2000-10Hz, log or linear sweep rate, 20G for 1 min, 1.5mm each apply 3x per axis over 变频振动(VVF) 10-2000-10Hz,对数或线性扫频,20G, 1 分钟,1.5mm,每轴 3 遍以上	6hrs	0/6
Salt Spread (SS) 35℃, 30g/m2/day 盐雾试验 35℃,30 克/平方米/天	48hrs	0/11

ltem 项目	Symbol	Test Condition		or Judgment 定标准
	符号	测试条件	Min. 最小	Max. 最大
Forward Voltage 正向电压	Vf	IF=Typical Current 典型电流		U.S.L x1.1
Luminous Intensity 光功率	MW	IF=Typical Current	L.S.L x0.7	
peak wavelength 峰值波长	nm	IF=Typical Current		U.S.L x1.1

PRECAUTION FOR USE 使用注意事项

(1) This device should not be used in any type of fluid such as water, oil, organic solvent, etc. When washing is required, IPA should be used.

本器件不得用于水、油、有机溶剂等任何流体中。如需清洁,请使用异丙醇进行清洗。

(2) When the LEDs are illuminating, operating current should be decided after considering the ambient maximum temperature.

当 LED 发光工作时,应根据环境最高温度来确定工作电流。

(3) LEDs must be stored to maintain a clean atmosphere. If the LEDs are stored for 3months or more after being shipped from ShineOn, a sealed container with a nitrogen atmosphere should be used for storage.

LED 储存环境须保持清洁。如果 LED 从易美发货后需储存 3 个月或更长时间,则应使用氮气柜讲行储存。

(4) The LEDs must be used within seven days after opening the moisture proof packing. Repack unused Products with anti-moisture packing, fold to close any opening and then store in a dry place.

LED 须在打开防潮包装后七天内使用。用防潮包装重新包装未使用的产品,折叠以封住开口,然后存放在干燥的地方。

- (5) The appearance and specifications of the product may be modified for improvement without notice. 产品外观及规格如有改进,恕不另行通知。
- (6) This LED is sensitive to the static electricity and surge. It is recommended to use a wrist Band or anti-electrostatic glove when handling the LEDs.

LED 对静电和浪涌很敏感。在处理 LED 时,建议使用防静电腕带或防静电手套。

(7) On manual soldering, a solder tip must be needed as grounded for usage. If over voltage which exceeds the absolute maximum rating is applied to LEDs, it will cause damage LEDs and result in destruction. Damaged LEDs will show some unusual characteristics such as leak current remarkably increase ,turn-on voltage becomes lower and the LEDs get unlighted at low current.

手工焊接时,焊接头必须接地。如果对 led 施加超过绝对最大额定值的过电压,会对 led 造成损坏。损坏的 led 会出现一些不寻常的特性,如漏电流明显增加,接通电压降低,低电流时 led 不亮。